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10-30-1998

U.S. DEPARTMENT OF COMMERCE

Patent and Trademark Office

Attorney Docket No.: 43889-826

100863611

To the Honorable Commissioner of Patents and trauemarks: riease record the attached original documents or copy thereof.

1. Name of conveying party(ies): Shinichi IMAI and Nobuhiro JIWARI

Additional name(s) of conveying party(ies) attached? No

Name and address of receiving party(s):
 Matsushita Electronics Corporation
 1-1, Saiwai-cho, Takatsuki-shi, Osaka 569-1193 JAPAN

Additional name(s) & address(es) attached? Yes X No

3. Nature of conveyance:

Assignment
Merger
Security Agreement
Change of Name
Other

Execution Date: October 21, 1998

4. Application number(s) or patent number(s): 09//18431

If this document is being filed together with a new application, the execution date of the application is: October 21, 1998

- A. Patent Application No.(s)
- B. Patent No.(s)

Additional numbers attached? No

. Name and address of party to whom correspondence concerning document should be mailed:

Edward E. Kubasiewicz, Esq. McDermott, Will & Emery 600 13th Street, N.W. Washington, DC 20005

6. Total number of applications and patents involved: 1

X Authorized to be charged to deposit Account

8. Deposit Account No: 13-0203

(Attached duplicate copy of this page if paying by deposit account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Edward E. Kubasiewicz, No. 30,020

Name of Person Signing

Signature/Date: 26 October 1998

Total number of pages including cover sheet, attachments, and document: 3

Mail documents to be recorded with required cover sheet information to:

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PATENT REEL: 9538 FRAME: 0959

Attorney Docket No.: 4389-826

ASSIGNMENT

WHEREAS, Shinichi IMAI, Nobuhiro,	IIWARI
hereinafter called the "Assignors," have jointly	
DRY ETCHING METHOD AND SEMICOND	UCTOR DEVICE FABRICATION METHOD
	, for which they have:
	nited States Letters Patent on as (Serial No); or
(b) executed an application f	or United States Letters Patent on; and
WHEREAS, Matsushita Electronics Co a corporation organized and existing under the l	•
1-1, Saiwai-cho, Takatsuki-shi, Osaka 569-119	3, Japan ,
hereinafter called the "Assignee," is desirous of a to said invention, the application above identified may be obtained to said invention, as hereinafte	d, and in, to and under any Letters Patent which

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that for and in consideration of the sum of One Dollar (\$1.00), and other valuable and legally sufficient considerations, the receipt of which by said Assignors from the said Assignee is hereby acknowledged, the said Assignors have sold, assigned and transferred, and by these presents do sell, assign and transfer unto the said Assignee, the entire, right, title and interest for the United States in and to the invention and application hereinabove identified, and any Letters Patent of the United States that may issue for said invention, together with the entire right, title and interest in and to said invention and applications for Letters Patent and Letters Patent therefor, in all countries foreign to the United States, including the full right to claim for any such application all benefits and priority rights under any applicable convention; to have and to hold for the sole and exclusive use and benefit of the said Assignee, its successors and assigns, to the full end of the term or terms for which any and all of said Letters Patent for said inventions may issue.

And the said Assignors do hereby covenant and agree, for themselves and their legal representatives, that they will assist their said Assignee in the prosecution of the application

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herein identified; in the making and prosecution of any other applications for Letters Patent that the said Assignee may elect to make covering the invention herein identified, as hereinabove set forth; in vesting in the said Assignee like exclusive title in and to all such other applications and Letters Patent; and in the prosecution of any interference which may arise involving said invention, or any application or Letters Patent herein contemplated; and that they will execute and deliver to the said Assignee any and all additional papers which may be requested by the said Assignee to fully carry out the terms of this Assignment.

And the Commissioner of Patents and Trademarks is hereby authorized and requested to issue Letters Patent to the said Assignee in accordance the terms of this Assignment.

IN TESTIMONY WHEREOF, the said Assignors have hereunto set their hands and affixed their seals.

Date: 0ct. 21, 1998	Shinichi Imai Shinichi IMAI	(Seal)
WITNESSED:	Leiji Phuda	
Date: 0ct. 21, 1998	Seiji OKUDA	(Seal)
Date: 0ct. 21, 1998	7 darumi Jagueki Harumi TAGUCHI	(Seal)
Date: 0ct. 21, 1998	Nobuhiro Jiwas Nobuhiro JIWARI	(Seal)
WITNESSED:	0 1	
Oct. 21, 1998 Date:	Seiji OKUDA	(Seal)
Oct. 21, 1998 Date:		(Seal)

RECORDED: 10/26/1998